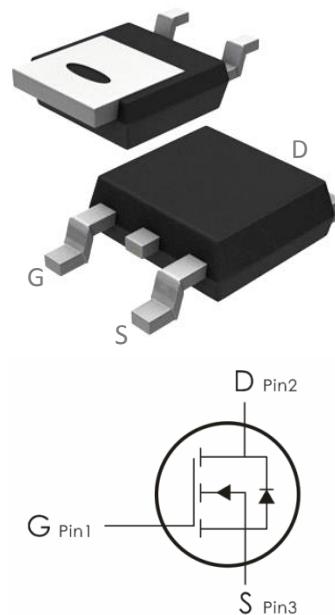


## Description:

This N-Channel MOSFET uses advanced trench technology and design to provide excellent  $R_{DS(on)}$  with low gate charge. It can be used in a wide variety of applications.



## Features:

- 1)  $V_{DS}=600V, I_D=4A, R_{DS(on)}<2.5 \Omega @ V_{GS}=10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra  $R_{DS(on)}$ .
- 5) Excellent package for good heat dissipation.

## Absolute Maximum Ratings: ( $T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	600	V
$V_{GS}$	Gate-Source Voltage	$\pm 30$	V
$I_D$	Continuous Drain Current- $T_C=25^\circ C$	4	A
	Continuous Drain Current- $T_C=100^\circ C$	2.5*	
	Pulsed Drain Current <sup>1</sup>	16*	
$E_{AS}$	Single Pulse Avalanche Energy <sup>2</sup>	240	mJ
$P_D$	Power Dissipation, $T_C=25^\circ C$ <sup>4</sup>	51	W
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	°C

## Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{eJC}$	Thermal Resistance,Junction to Case	2.5	°C/W
$R_{eJA}$	Thermal Resistance,Junction to Ambient	83	

**Electrical Characteristics:** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

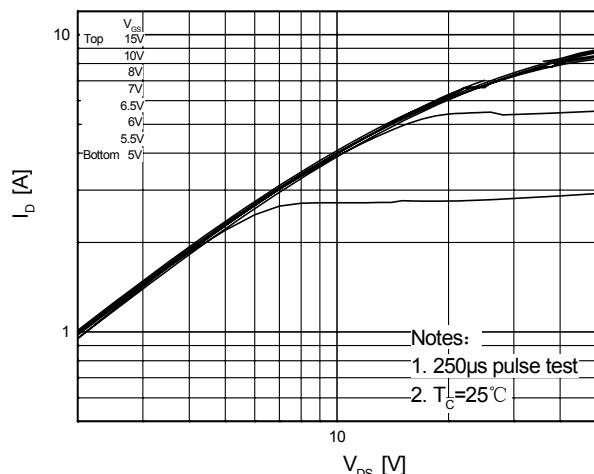
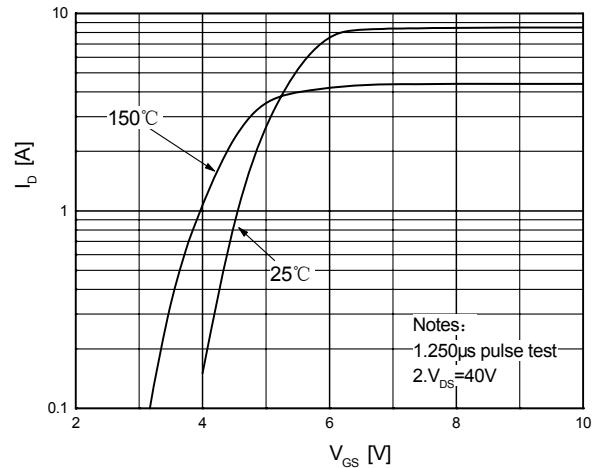
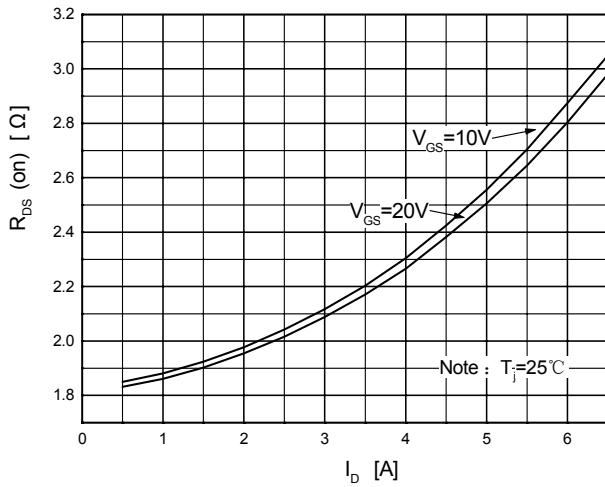
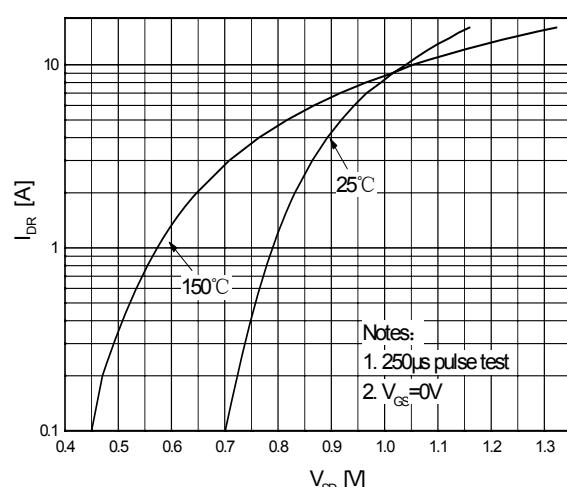
Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250 \mu\text{A}$	600	---	---	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{GS}=0\text{V}, V_{DS}=600\text{V}$	---	---	10	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{GS}=\pm 30\text{V}, V_{DS}=0\text{A}$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	GATE-Source Threshold Voltage	$V_{GS}=V_{DS}, I_D=250 \mu\text{A}$	2	---	4	V
$R_{DS(\text{ON})}$	Drain-Source On Resistance	$V_{GS}=10\text{V}, I_D=2\text{A}$	---	2	2.5	$\Omega$
		$V_{GS}=4.5\text{V}, I_D=4\text{A}$	---	50	60	
$G_{FS}$	Forward Transconductance 4	$V_{DS}=40\text{V}, I_D=2\text{A}$	---	4.7	---	S
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=25\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$	---	710	920	pF
$C_{oss}$	Output Capacitance		---	65	85	
$C_{rss}$	Reverse Transfer Capacitance		---	14	19	
<b>Switching Characteristics</b> <sup>4,5</sup>						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD}=300\text{V}, I_D=4\text{A}, V_{GS}=10\text{V}, R_{\text{GEN}}=25\Omega$	---	20	50	ns
$t_r$	Rise Time		---	55	120	ns
$t_{d(off)}$	Turn-Off Delay Time		---	70	150	ns
$t_f$	Fall Time		---	55	120	ns
$Q_g$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=480\text{V}, I_D=4\text{A}$	---	27	30	nC
$Q_{gs}$	Gate-Source Charge		---	3.6	---	nC
$Q_{gd}$	Gate-Drain "Miller" Charge		---	13.1	---	nC
<b>Drain-Source Diode Characteristics</b>						
$V_{SD}$	Source-Drain Diode Forward Voltage	$V_{GS}=0\text{V}, I_S=4\text{A}$	---	---	1.4	V

<b>trr</b>	Reverse Recovery Time <sup>4</sup>	$V_{GS}=0V, I_S=4.0A$ $dI_F/dt=100A/\mu s$	330	---	Ns
<b>qrr</b>	Reverse Recovery Charge <sup>4</sup>		2.67	---	nc

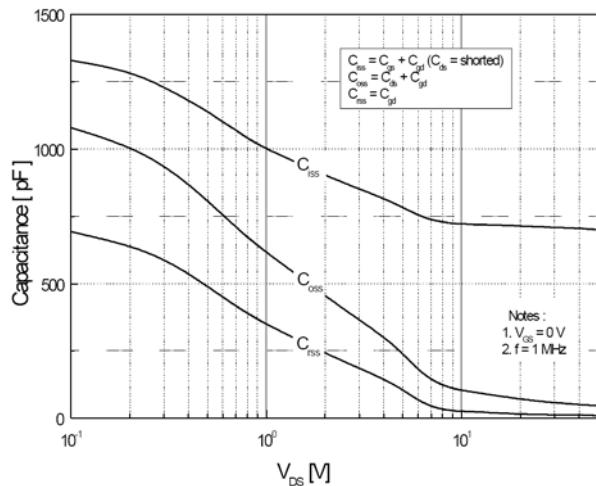
**Notes:**

- 1: Pulse width limited by maximum junction temperature
- 2: L=25mH,  $I_{AS}=4.0A$ ,  $V_{DD}=50V$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ C$
- 3 :  $I_{SD} \leq 4.0A$ ,  $di/dt \leq 200A/\mu s$ ,  $VDD \leq BV_{DSS}$ , Starting  $T_J=25^\circ C$
- 4: Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycles  $\leq 2\%$
- 5: Essentially independent of operating temperature

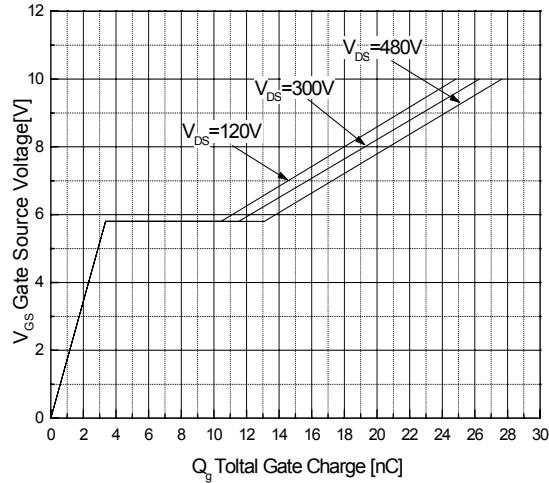
**Typical Characteristics:** ( $T_C=25^\circ C$  unless otherwise noted)

**On-Region Characteristics**

**Transfer Characteristics**

**On-Resistance Variation vs.  
Drain Current and Gate Voltage**

**Body Diode Forward Voltage Variation  
vs. Source Current and Temperature**


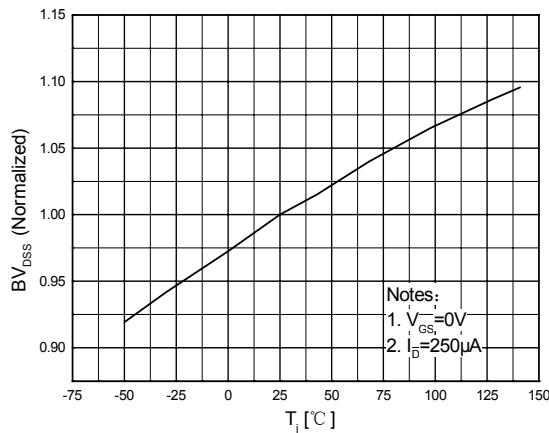
### Capacitance Characteristics



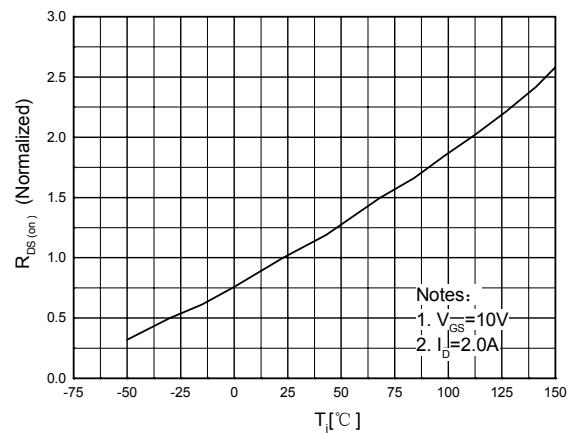
### Gate Charge Characteristics



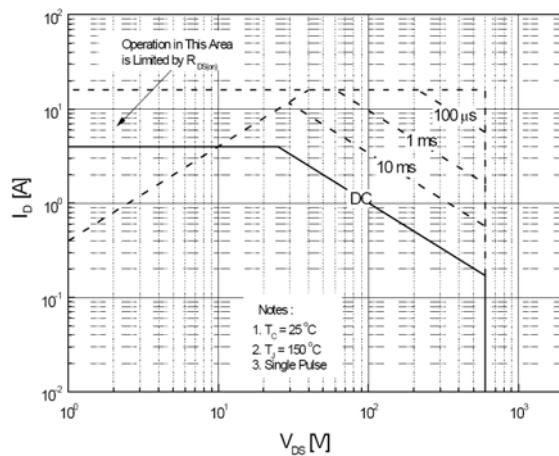
### Breakdown Voltage Variation vs. Temperature



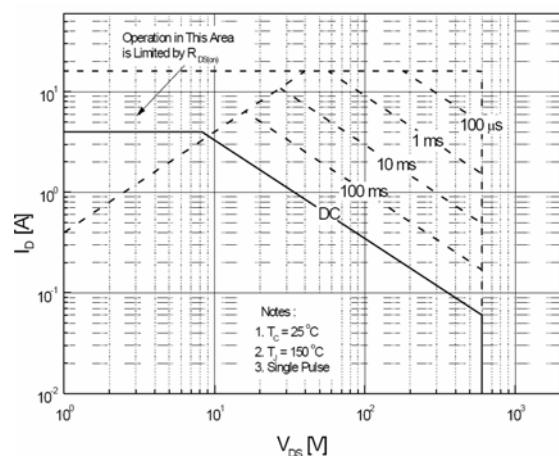
### On-Resistance Variation vs. Temperature



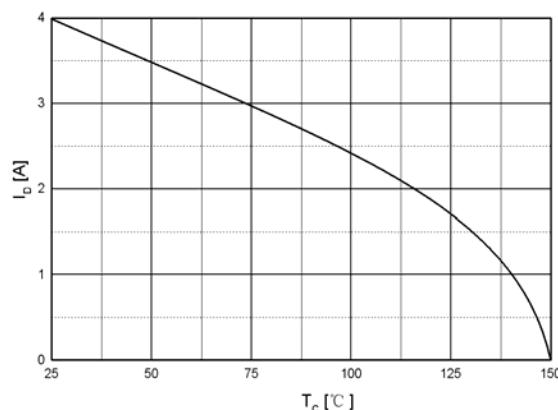
### Maximum Safe Operating Area



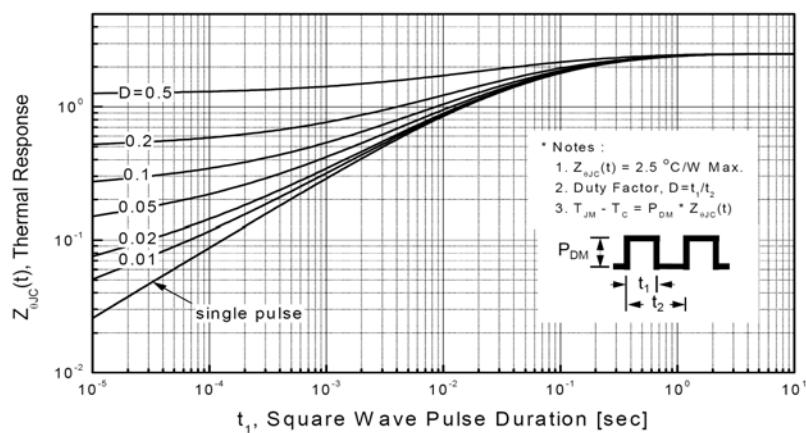
### Maximum Safe Operating Area



### Maximum Drain Current vs. Case Temperature



### Transient Thermal Response Curve



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